

NOTICE OF PUBLIC HEARING

Notice is hereby given that on May 10 2022, a public hearing, which may be continued or adjourned, will be held via toll-free telephone conference by the Ohio Higher Educational Facility Commission commencing at 11:00 a.m. local time with respect to the proposed issuance by the Ohio Higher Educational Facility Commission (the “Issuer”) of State of Ohio Higher Educational Facility Revenue Bonds (University of Dayton 2022 Project) (the “Bonds”) in an aggregate principal face amount not to exceed \$161,000,000 in one or more series, pursuant to Chapter 3377 and Sections 9.98 through 9.983, Ohio Revised Code, as amended (collectively, the “Act”), in connection with a plan of finance for the benefit of University of Dayton (the “University”), an Ohio nonprofit corporation. The Bonds will be issued as qualified 501(c)(3) bonds under Section 145 of the Internal Revenue Code of 1986, as amended, and the proceeds of the Bonds will be used to finance and refinance costs of acquiring, constructing, equipping, furnishing, installing and otherwise improving “educational facilities” (as defined in the Act, “Educational Facilities”) of the University.

The proceeds of the Bonds will be made available to the University to finance and refinance costs of the Educational Facilities located on the University’s main campus, the administrative offices of which are located at 300 College Park, Dayton, Ohio 45469 and at or in close proximity to the University’s athletic arena located at 1801 South Edwin C. Moses Blvd., Dayton, Ohio 45417.

The initial legal owner or principal user of the Educational Facilities financed and refinanced by the Bonds is the University.

The Bonds will be special obligations of the Issuer and will not constitute a debt or a pledge of the faith and credit or the taxing power of the Issuer or the State of Ohio.

Persons wishing to express their views on the proposed Bonds may submit their views in writing regarding the proposed Bonds and the location and nature of the Educational Facilities to be financed and refinanced or participate in the hearing by teleconference. The teleconference may be accessed by dialing the toll-free number 1-855-228-1766, followed by the pass code 18638006#.

Any written submissions should be: mailed to the Issuer at Ohio Higher Educational Facility Commission, 25 South Front Street, 2nd Floor, Columbus, Ohio 43215; or emailed to the Issuer at bchristensen@highered.ohio.gov. Written statements should be clearly marked “Re: State of Ohio Higher Educational Facility Revenue Bonds (University of Dayton 2022 Project).” Written submissions should be mailed or emailed in sufficient time to be received before the referenced public hearing on May 10, 2022.

STATE OF OHIO,
acting by and through the Ohio Higher Educational
Facility Commission, Thomas F. Needles, Chair